## PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

**SUBMISSION TYPE: NEW ASSIGNMENT ASSIGNMENT** 

NATURE OF CONVEYANCE:

#### **CONVEYING PARTY DATA**

Name	Execution Date
SEUNG BUM KIM	12/28/2009

### **RECEIVING PARTY DATA**

Name:	HYNIX SEMICONDUCTOR INC.		
Street Address:	SAN 136-1, AMI-RI, BUBAL-EUB, ICHEON-SI		
City:	y: KYOUNGKI-DO		
State/Country:	REPUBLIC OF KOREA		

### PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12649605	

## **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: **CU-7993 WWP/NK** 

NAME OF SUBMITTER: Woochoon W. Park

Total Attachments: 2

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> **PATENT** REEL: 023718 FRAME: 0137

501054186

# UNITED STATES OF AMERICA ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR(S) of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

### ASSIGNOR:

### Seung Bum KIM

#104-1208, Hyeonjin Apt., Ganam-myeon, Yeoju-gun, Gyeonggi-do 469-709, Korea

hereby sells, assigns and transfers to

## **ASSIGNEE:**

### Hynix Semiconductor Inc.

San 136-1, Ami-ri, Bubal-eub, Icheon-si, Kyoungki-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the Application entitled

# SEMICONDUCTOR DEVICE AND METHOD OF FABRICATING THE SAME

which app	lication was		
4	(a) executed on event date herew	rith	
	(b) filed as Serial No.	on	
and, in an	d to all Letters Patent to be obtair to the contair to the contain the contain the contact of the contact to the contact the c	ned for said invention by the above te, reissue or re-examination thereo	application or

ASSIGNOR hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and

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deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

December 25, 2009

Date

Seung hum Kim
INVENTOR Seung Bum KIM

0699P/1 (U.S. rights)

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